

SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

2SK4073LS — General-Purpose Switching Device **Applications**

Features

- · Ultralow ON-resistance.
- · Load switching applications.
- · Avalanche resistance guarantee.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		90	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	360	Α
Allowable Power Dissipation	D-		2.0	W
	PD	Tc=25°C	40	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		850	mJ
Avalanche Current *2	IAV		70	Α

Note: *1 VDD=30V, L=200 μ H, IAV=70A

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			1.1
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	VDS=10V, ID=1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =45A	44	74		S
Static Drain-to-Source On-State Resistance	RDS(on)1	I _D =45A, V _{GS} =10V		3.8	5.0	mΩ
	RDS(on)2	ID=45A, VGS=4V	-	5.0	7.0	mΩ

Marking: K4073 Continued on next page.

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^{*2} L≤200µH, Single pulse

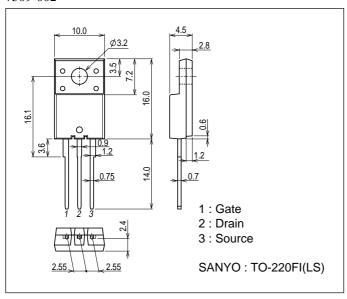
2SK4073LS

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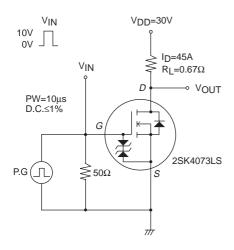
Parameter	Symbol	Conditions		Ratings		
	Symbol		min	typ	max	Unit
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		12500		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		1200		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		950		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		80		ns
Rise Time	t _r	See specified Test Circuit.		630		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		860		ns
Fall Time	tf	See specified Test Circuit.		750		ns
Total Gate Charge	Qg	V _{DS} =30V, V _{GS} =10V, I _D =90A		220		nC
Gate-to-Source Charge	Qgs	VDS=30V, VGS=10V, ID=90A		30		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =30V, V _{GS} =10V, I _D =90A		55		nC
Diode Forward Voltage	V _{SD}	IS=90A, VGS=0V		0.9	1.2	V

Package Dimensions

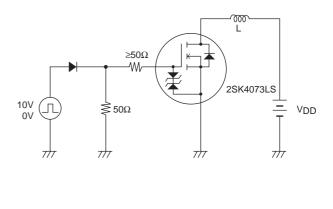
unit : mm (typ) 7509-002

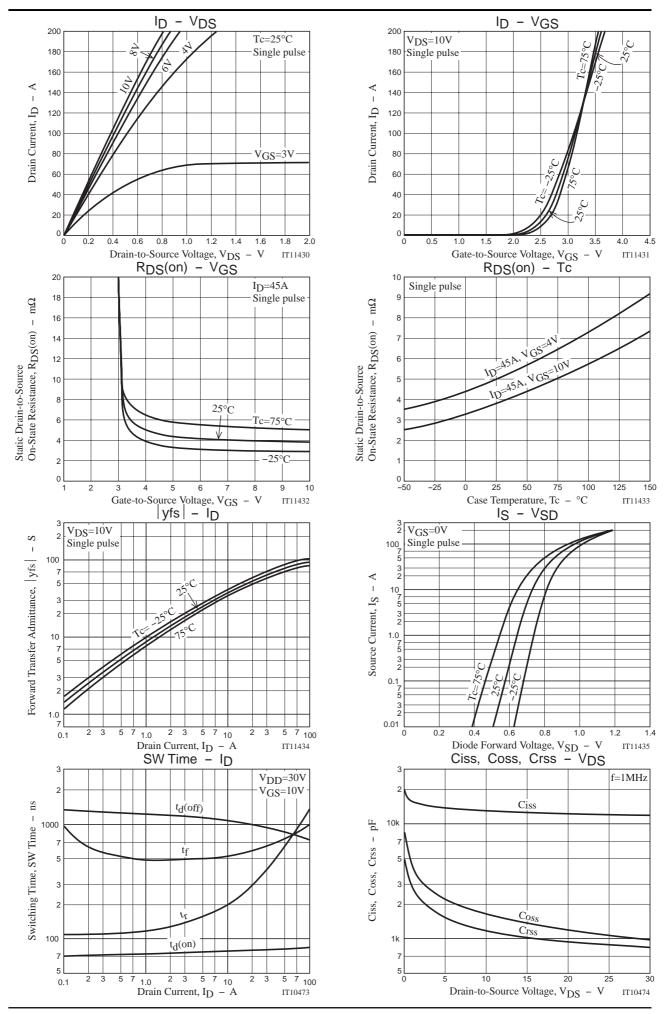


Switching Time Test Circuit

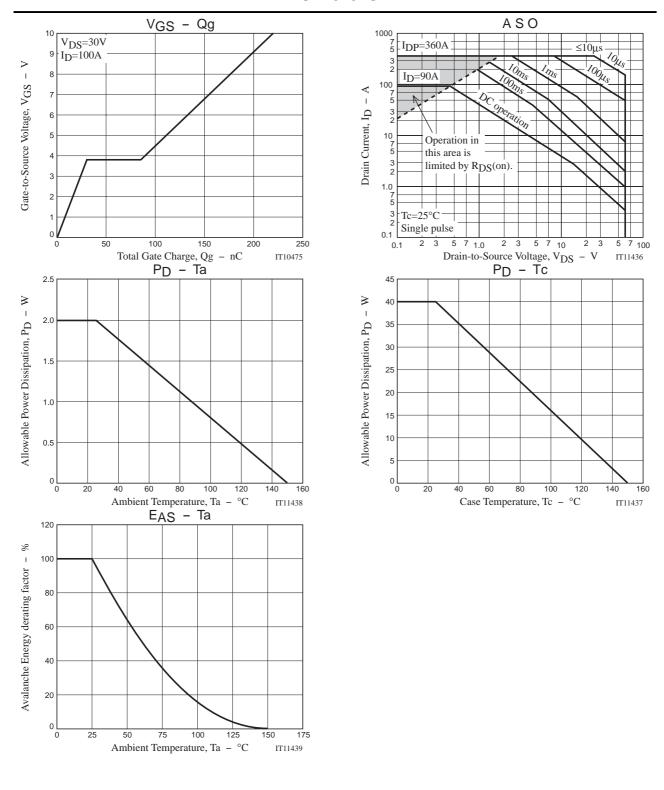


Avalanche Resistance Test Circuit





2SK4073LS



Note on usage: Since the 2SK4073LS is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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